# **Tentative**

DA26101			
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### DA26101

Silicon epitaxial planar type

For high speed switching circuits

Marking Symbol: A1

Package Code: ML2-N3-B

Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	80	V
Maximum peak reverse voltage	VRM	80	V
Forward current	IF	100	mA
Peak forward current	IFM	225	mA
Non-repetitive peak forward surge current *1	IFSM	500	mA
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

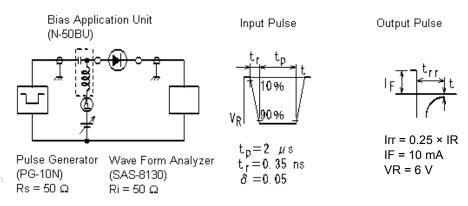
Pin name 1. Cathode 2. Anode

Note: 1. \*1 t = 1 s

### Electrical Characteristics Ta = 25 °C±3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 100 mA		0.92	1.20	V
Reverse voltage	VR	IR = 100 μA	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V , f = 1 MHz			1.2	pF
Reverse recovery time *1	trr	IF = 10 mA, VR = 6 V Irr = 0.25 x IR			3	ns

- Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. Absolute frequency of input and output is 100 MHz.
  - 3. \*1 trr test circuit

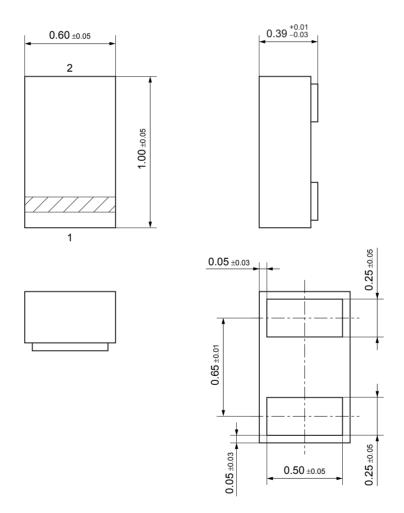


#### **Packing**

Embossed type (Thermo-compression sealing): 10 000 pcs / reel

2010.4.7	2010.7.27
Prepared	Revised

ML2-N3-B Unit: mm



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